

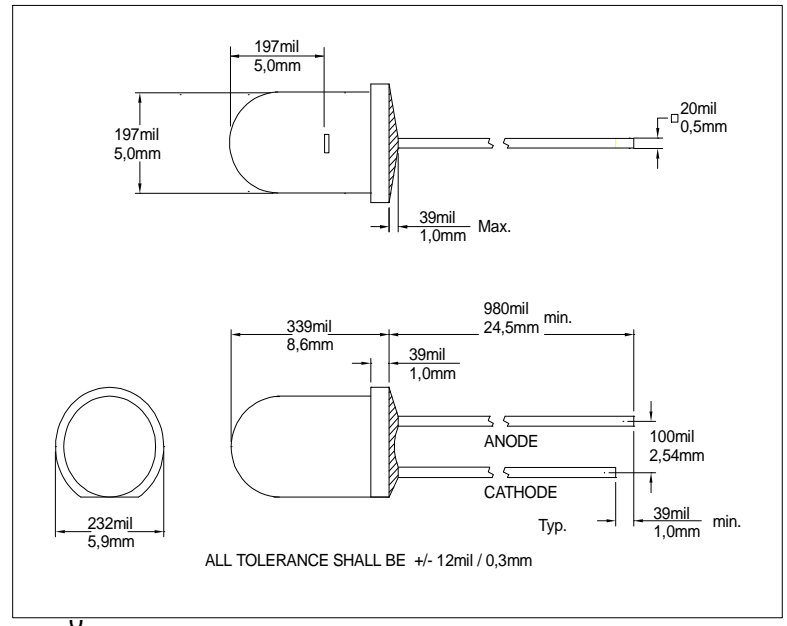
Low-Current IR-LED

855nm

FQR56593BDP

Features

- * Standard design LED for general purpose
Based on double hetero structure of GaAlAs
- * Special construction with internal Diffusor
- * Fast switching time : typical <20ns
- * High cut-off frequency of >20Mhz @-3dB
- * High power for T1 3/4 case with 17° full angle
- * Water-clear package style without stand-off
- * Application : Open-Air communication / IrDa
IR-Flash-Lights
Medical instruments
Light interrupter and switches



Electrical and optical characteristics and absolute maximum ratings (Ta=25°C unless otherwise noted)

Symbol	Parameter	MIN	Typ	MAX	Unit	Test conditions
I _F	DC Forward current		50	70	mA	
I _{PEAK}	Peak Forward current			250	mA	T _p < 10μsec. ; T ₁ :1:100 ; R _{therm} < 100 K/W
V _F	Forward Voltage	1,35	1,6	2,1	V	I _F = 50mA
V _F	Forward Voltage	1,1	1,3	1,7	V	I _F = 3mA
V _R	Reverse Voltage	5			V	I _{rev} = 100μA
λ _{Peak}	Peak Wavelength	840	855	870	nm	I _F = 50mA
Δλ _{0,5}	Bandwidth of half power	25	30		nm	I _F = 50mA
t _f	Fall time		20		ns	I _F = 50mA
t _r	Rise time		20		ns	I _F = 50mA
Φ _E	Total Power Output	24	32		mW	I _F = 50mA
I _E	Radiant Intensity	50	75		mW/sr	I _F = 50mA
I _E	Radiant Intensity	2	3,5		mW/sr	I _F = 3mA
A	Chip size		0,07		mm ²	Chip size : 260μmX260μm
2Φ _{0,5}	Emission Angel	14	17	22	deg.	Φ _E = 50%
TK _{V_F}	Temp.Coeff. of Forward Voltage		- 2		mV/K	
TK _F	Temp.Coeff. of Radiant Power		- 0,4		%/K	
T _{Operating}	Operating Temperature	- 25		85	°C	
T _{Storage}	Storage Temperature	- 25		85	°C	
T _{Soldering}	Soldering Temperature			260	°C	2mm from case @ 5 sec.
Θ _{j-PIN}	Thermal Resistance		450		K/W	
P _{tot}	Total Power Dissipation			230	mW	derate above 45°C 2,5mW/K

Order Informations :

FQR56593BDP

Bulk (1000 pcs./bag)

Fietje reserves the right to make changes at any time in order to improve design and to supply the best product possible, contact Fietje for latest device specification sheets before using.